PRODUCT CHANGE NOTICE				
PART NUMBER(S):	PCN No.: 06-0130-44			
Please see attachment.	DATE: January 30, 2006			
PART DESCRIPTION:				
Power Management and Interface Products – Change in Wafer Fabrication Site				
LEVEL OF CHANGE:				
[X] Level I, Customer Approval.	[ ] Level II, Customer Information.			
PRODUCT ATTRIBUTE AFFECTED:				
<ul> <li>[ ] Material Change</li> <li>[ ] Design Change</li> <li>[X] Process Change</li> <li>[X] Other, Explain: Wafer Fabrication</li> </ul>	[ ] Data Sheet Change [ ] Package Change [ ] Packing / Shipping n Site Transfer			
DESCRIPTION OF CHANGE:				
Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry BCD. See attached Product List no. 44.				
REASON FOR CHANGE:				
Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.				
FABRICATION PROCESS QUALIFICATION COMPLETED (DATE): May 1, 2006  PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE): May 1, 2006				

<sup>\*</sup> Samples representative of product from the Product Family being transferred.



	PRODUCT CH	HANGE NOTICE	
EARLIEST DATE OF PRODUC SHIPMENTS: July 30, 2006	CTION		
EFFECTIVITY CHANGE DATE	OR DATE CODE: Wo	ork week associated wi	th earliest production shipment.
[ ] STANDARD DISTRIBUT	ION	[X]	CUSTOM DISTRIBUTION
PERSON TO CONTACT WITH	QUESTIONS:		
Fred Claussen			
VP Quality Assurance and Relia Sipex Corporation Phone Number: 408-935-7644 FAX NUMBER: 408-935-7678	ability		



## PRODUCT CHANGE NOTICE

PCN No.: 06-0130-44

List 44

**SPX4041M** 

SPX4041M-L

**SPX4041AS** 

SPX4041AS-L

**SPX4041N** 

**SPX4041N-L** 

SPX4041S

SPX4041S-L

SPX432AM

SPX432AM1

SPX432AM1-L

**SPX432AM5** 

SPX432AM5-L

SPX432AM-L

SPX432AN

SPX432AN-L

SPX432AS

SPX432AS-L

SPX432M

**SPX432M1** 

SPX432M1-L

**SPX432M5** 

SPX432M5-L

SPX432M-L

SPX432N

SPX432N-L

**SPX432S** 

**SPX432S-L**